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(12) **United States Design Patent** (10) **Patent No.:** **US D821,554 S**
Wilson et al. (45) **Date of Patent:** **** Jun. 26, 2018**

(54) **HEAT EXCHANGER INTERFACE SYSTEM**

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(**) Term: **15 Years**

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Related U.S. Application Data

(63) Continuation-in-part of application No. 29/473,168, filed on Nov. 19, 2013, which is a continuation-in-part of application No. 13/966,496, filed on Aug. 14, 2013, now Pat. No. 9,463,495.

(51) **LOC (11) Cl.** **23-03**

(52) **U.S. Cl.**
USPC **D23/323**

(58) **Field of Classification Search**
USPC D23/314, 323, 330, 386, 499; 165/181, 165/121, 166, 167, 170, 150, 151, 182, 165/172, 140, 41; 454/57, 49
CPC B01L 1/50; B01L 2300/185; F28D 15/00; B08B 15/023
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a heat exchanger interface system, as shown and described.

DESCRIPTION

FIG. 1 is a front view of a first embodiment of a heat exchanger interface system according to the present invention;

FIG. 2 is a rear view of the first embodiment of a heat exchanger interface system according to the present invention;

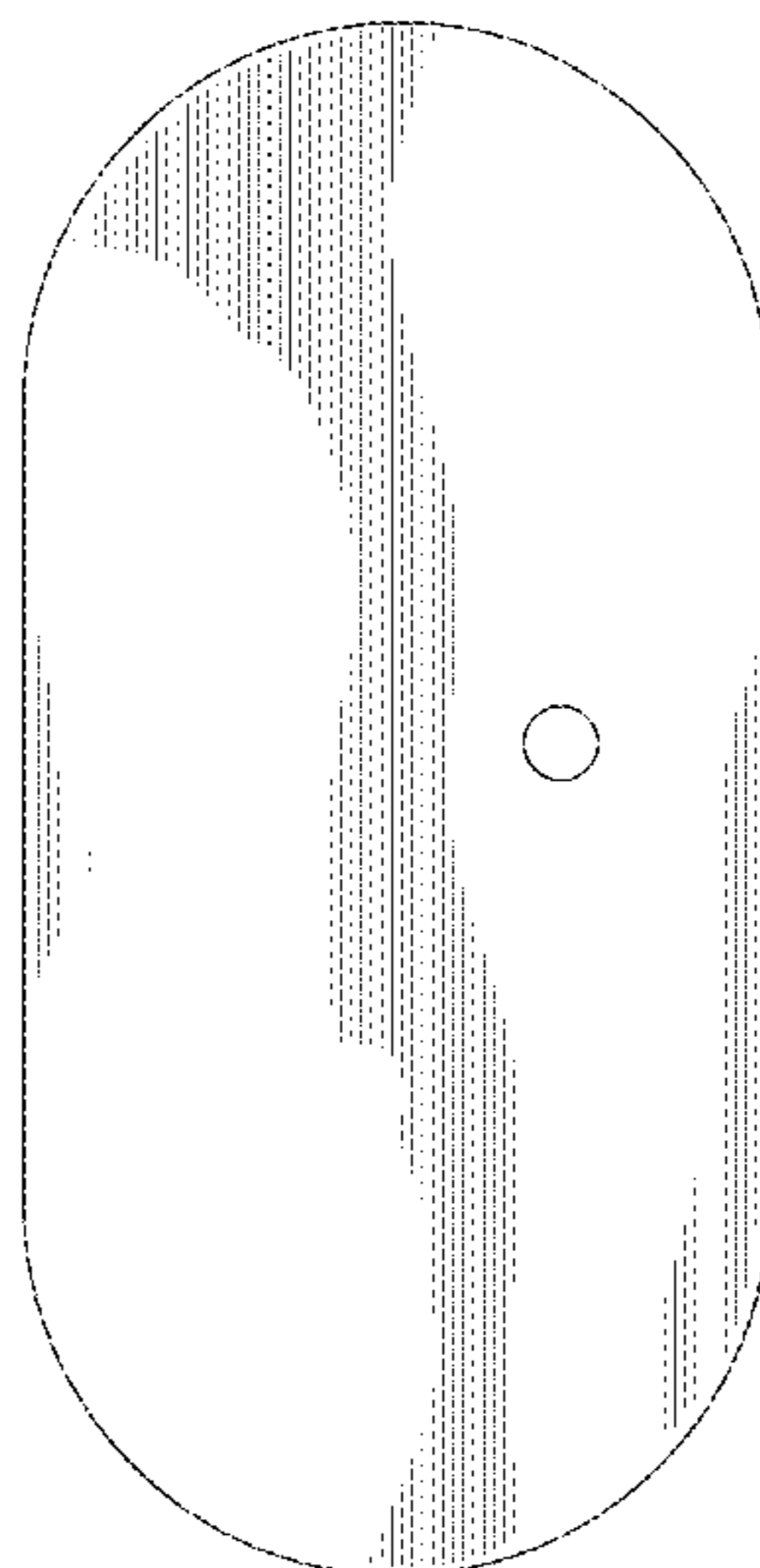
FIG. 3 is a side view of the first embodiment of a heat exchanger interface system according to the present invention;

FIG. 4 is a front view of a second embodiment of a heat exchanger interface system according to the present invention;

FIG. 5 is a rear view of the second embodiment of a heat exchanger interface system according to the present invention; and,

FIG. 6 is a side view of the second embodiment of a heat exchanger interface system according to the present invention.

1 Claim, 6 Drawing Sheets



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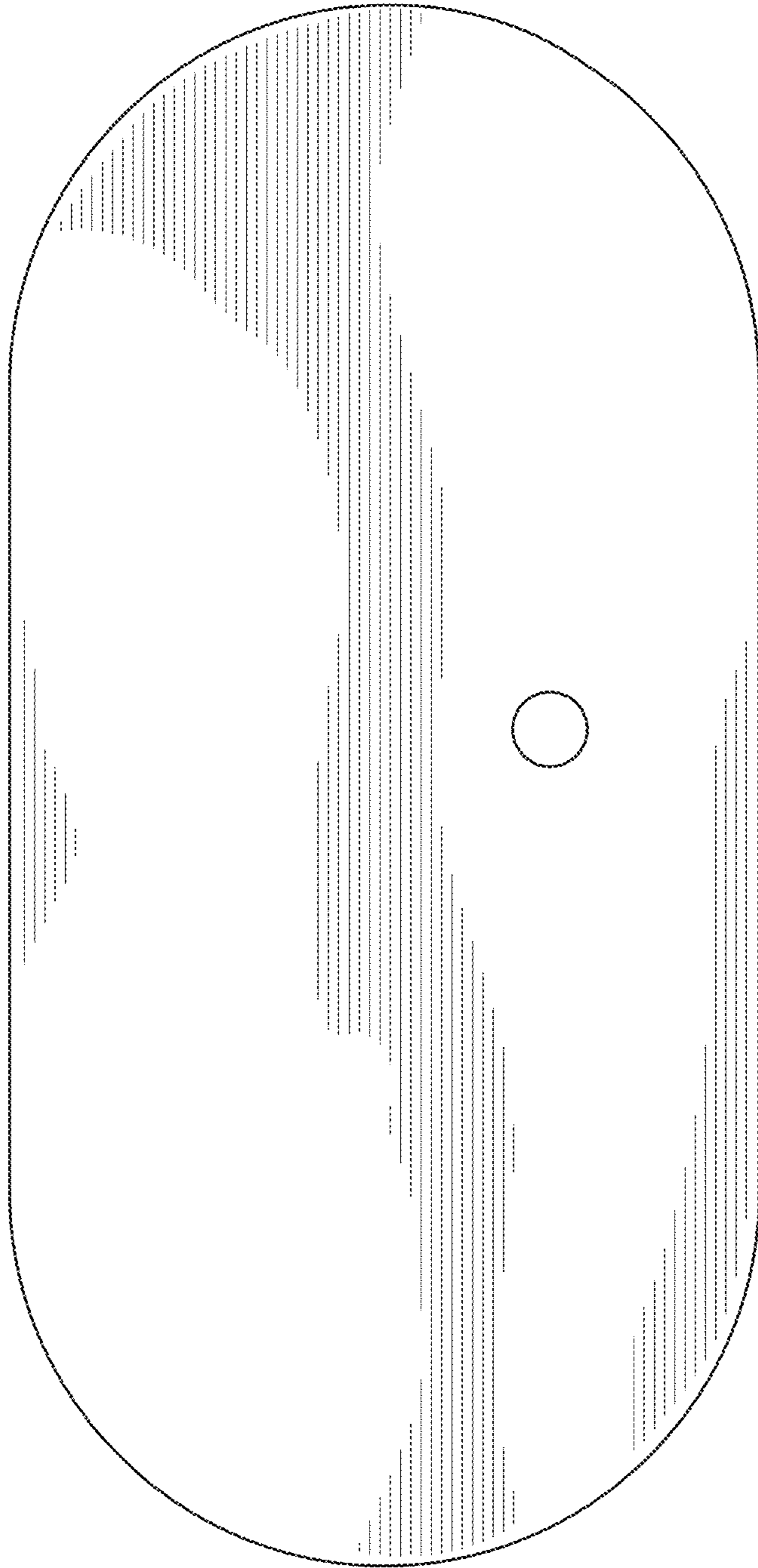


FIG. 1

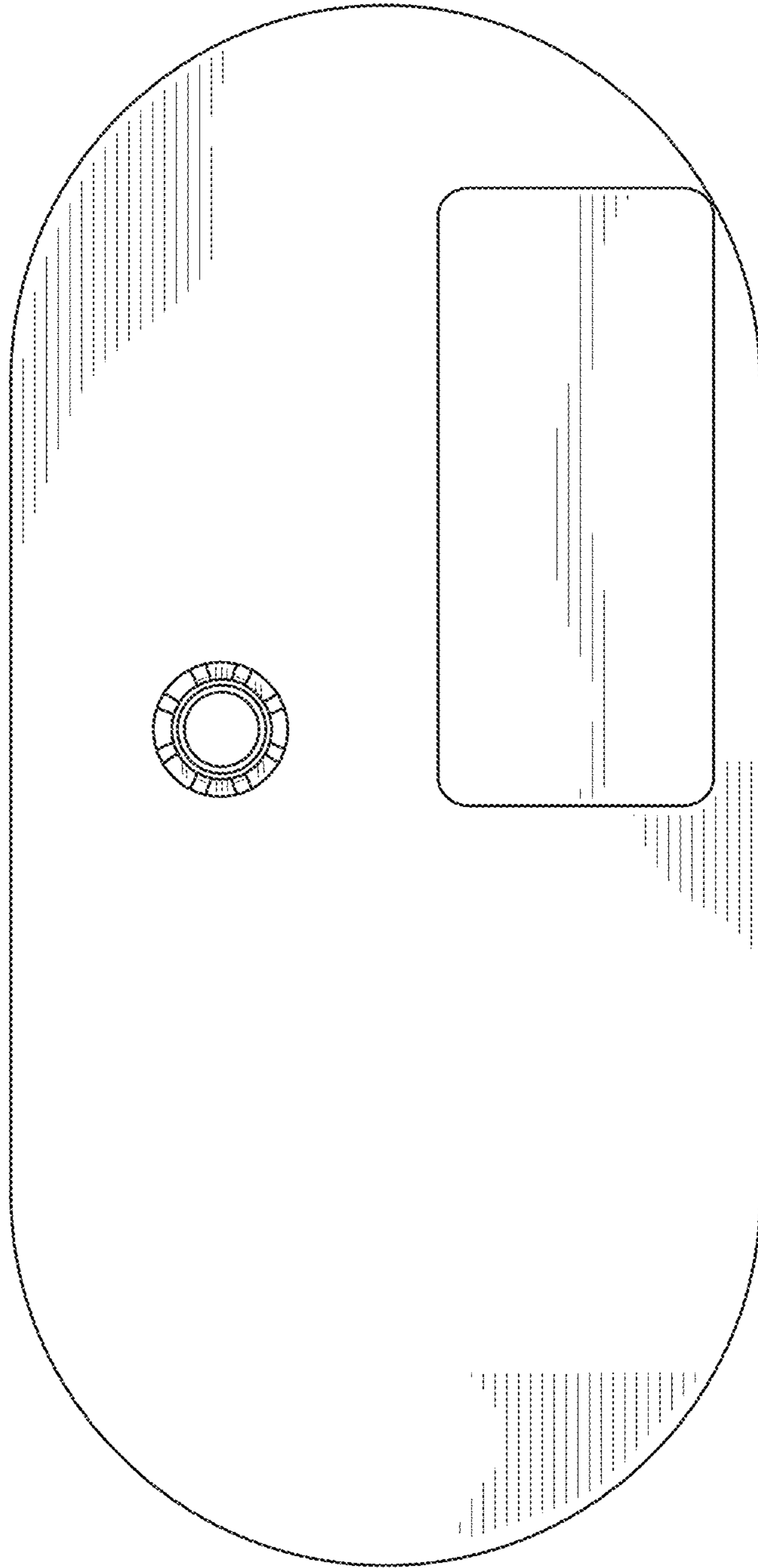


FIG. 2

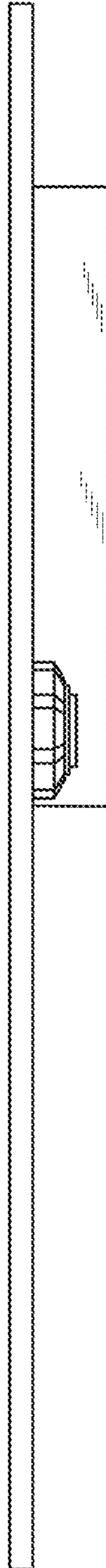


FIG. 3

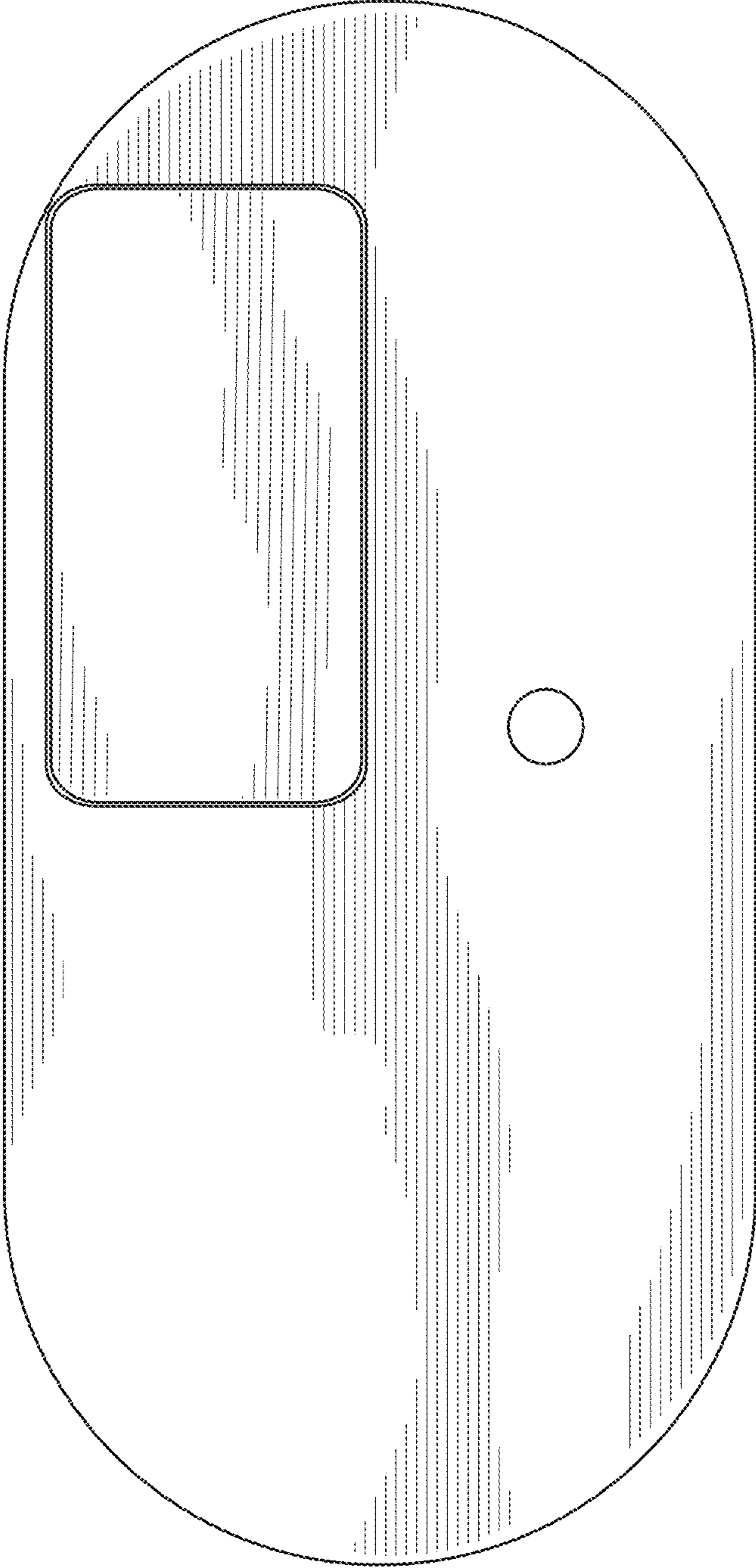


FIG. 4

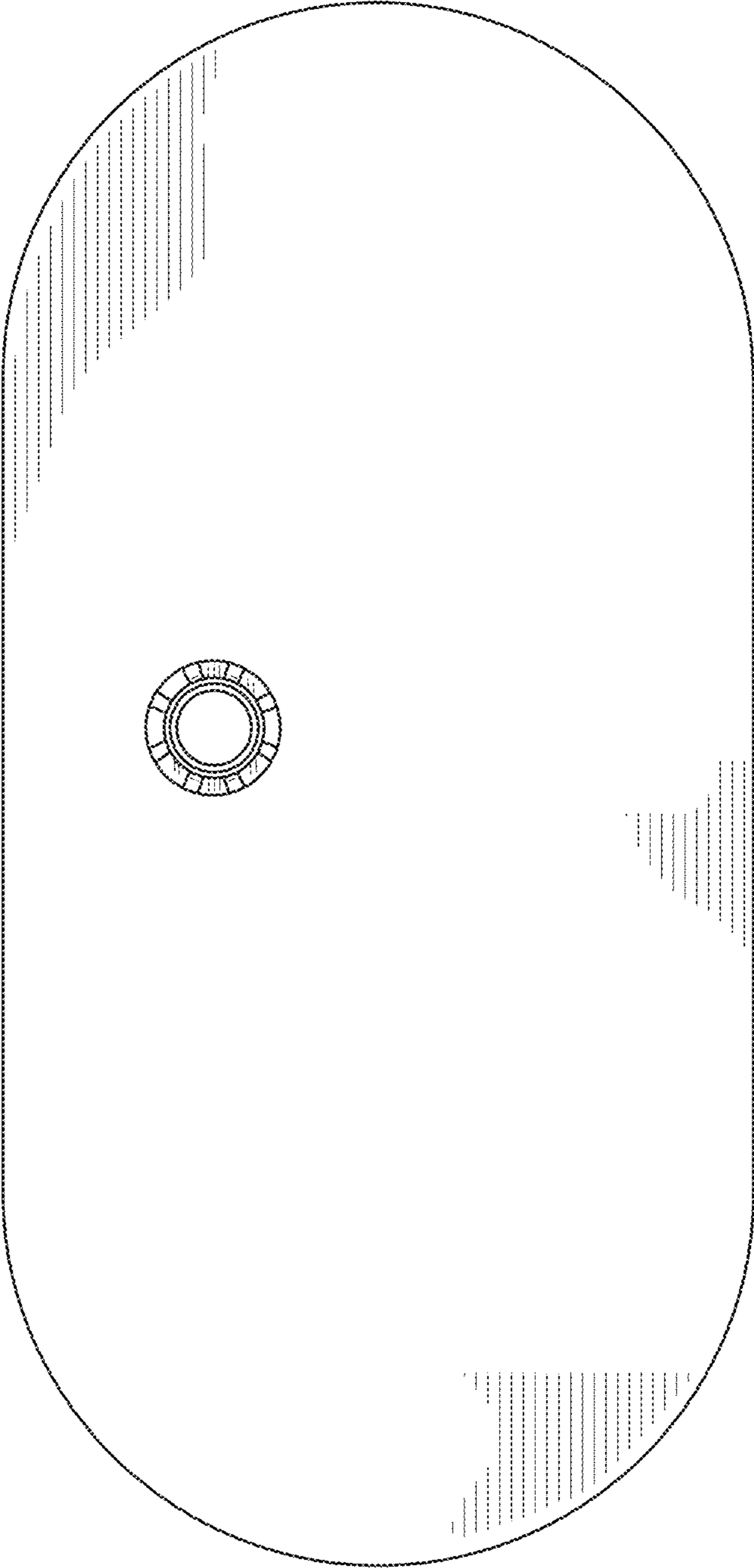


FIG. 5

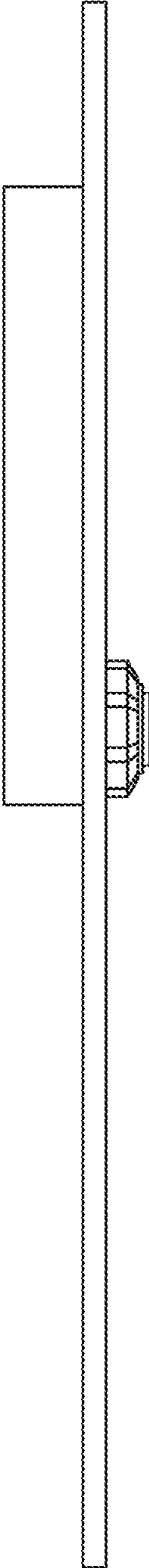


FIG. 6